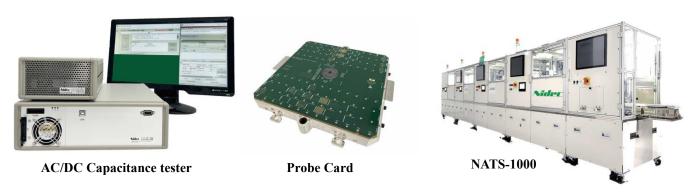




April 25, 2025

## Nidec Advance Technology to Exhibit Products at PCIM Expo & Conference 2025

Nidec Advance Technology Corporation ("Nidec Advance Technology") announced today that it will exhibit its products at PCIM Expo & Conference 2025, an event to be held in the city of Nürnberg, Germany from Tuesday, May 06 – Thursday, May 08, 2025.



This exhibition will be attended by companies of the power electronics industry to go beyond national borders to check out the latest trends in product development, share ideas in the entire industry, and provide solutions. In this conference, Nidec Advance Technology will feature some of its products ranging from chips for power devices to cutting-edge inspection systems, while demonstrating its HILS (Hardware-In-the-Loop Simulation) board, which helps to shorten product-development lead time.

Nidec Advance Technology remains dedicated to utilizing its industry-leading measuring and inspection technologies to contribute to the world's manufacturing businesses.

## **About PCIM Expo & Conference 2025**

- Period: Tuesday, May 06 Thursday, May 08, 2025
- Venue: NürnbergMesse in Nürnberg, Germany
- Booth: 4-432
- Official website: https://pcim.mesago.com/events/en.html

## Nidec Advance Technology's exhibits will include:

- NATS-1000/1700 Series (insulation/static characteristics /dynamic characteristics inspection equipment for IGBT/SiC power modules
- NATS-8000 Series (SiC module reliability testing equipment)
- R-1100 (motor test bench inverter & POWER HIL motor emulator)
- E-Transport Simulator® (AI-based xEV-modelling simulator)
- R-700 Series (multi-tester to measure AC/DC capacitance)
- TC-Probe (probe to measure semiconductor devices' temperatures)
- Chamber head Probe Card (high-voltage-adaptive pressurized-structure prove card)
- 3H + Probe (high-temperature & -voltage-adaptive probe)

-###-